



30V P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BVDSS	R _{DS(ON)} Max	I _D Max T _A = +25°C
-30V	10mΩ @ V _{GS} = -10V	-11A
	18mΩ @ V _{GS} = -4.5V	-8.3A

Description and Applications

This new generation MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Backlighting
- Power Management Functions
- DC-DC Converters

Features and Benefits

- Low Rds(ON) Ensures On-State Losses Are Minimized
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- Occupies just 33% of The Board Area Occupied by SO-8 Enabling Smaller End Product
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

https://www.diodes.com/products/automotive/automotive-products/.

 This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

https://www.diodes.com/quality/product-definitions/

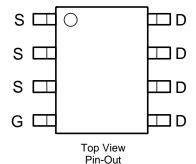
Mechanical Data

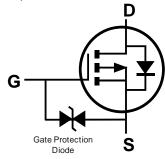
- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Lead Frame.
 Solderable per MIL-STD-202, Method 208 (23)
- Weight: 0.074 grams (Approximate)





Top View





Equivalent Circuit

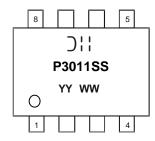
Ordering Information (Note 4)

Part Number	Case	Packaging
DMP3011SSS-13	SO-8	2, 500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



);; = Manufacturer's Marking
P3011SS = Product Type Marking Code
YYWW = Date Code Marking
YY or YY = Year (ex: 21 = 2021)
WW or WW = Week (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			VDSS	-30	V
Gate-Source Voltage			V_{GSS}	±25	V
Continuous Drain Current (Note 6) V _{GS} = -10V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	lo	-11 -8.8	Α
Continuous Drain Current (Note 7) V _{GS} = -10V	Steady State	$T_C = +25^{\circ}C$ $T_C = +70^{\circ}C$	lo	-32 -26	А
Maximum Continuous Body Diode Forward Currer	Is	-2.4	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			IDM	-90	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)			I _{SM}	-90	Α
Avalanche Current (Note 8) L = 1mH			las	-14	Α
Avalanche Energy (Note 8) L = 1mH			Eas	102	mJ

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	1.4	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	90	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	P _D	1.8	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Reja	68	°C/W
Thermal Resistance, Junction to Case (Note 7)	R ₀ JC	8.2	°C/W	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

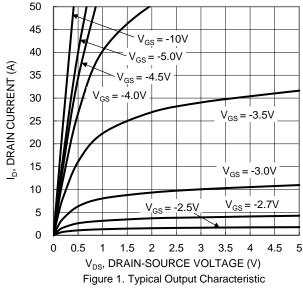
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV _{DSS}	-30		_	V	$V_{GS} = 0V, I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-1	μΑ	$V_{DS} = -24V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 25V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V _{GS(TH)}	-1.0	1	-3.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
Static Drain-Source On-Resistance	Dagger	1	8	10	mΩ	$V_{GS} = -10V, I_{D} = -11.5A$	
Static Drain-Source On-Resistance	RDS(ON)	_	13	18		$V_{GS} = -4.5V, I_{D} = -8.5A$	
Diode Forward Voltage	VsD	_	-0.7	-1.2	V	V _G S = 0V, I _S = -1A	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	Ciss	_	2380	_	pF		
Output Capacitance	Coss	_	341	_	pF	$V_{DS} = -15V, V_{GS} = 0V,$	
Reverse Transfer Capacitance	Crss	_	296	_	pF	f = 1.0MHz	
Gate Resistance	Rg		3		Ω	$V_{DS} = 0V, V_{GS} = 0V,$ f = 1.0MHz	
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	25	_	nC		
Total Gate Charge (V _{GS} = -10V)	Qg	_	46	_	nC	\/ 45\/ \	
Gate-Source Charge	Qgs	_	6.8	_	nC	$V_{DS} = -15V, I_{D} = -11.5A$	
Gate-Drain Charge	Qgd	_	13	_	nC		
Turn-On Delay Time	t _{D(ON)}	_	6	_	ns		
Turn-On Rise Time	t _R	_	22	_	ns	$V_{DD} = -15V$, $V_{GS} = -10V$,	
Turn-Off Delay Time	tD(OFF)	_	43	_	ns	$R_G = 6\Omega$, $I_D = -11.5A$	
Turn-Off Fall Time	tF	_	33	_	ns	7	
Reverse Recovery Time	trr	_	19	_	ns	1 44.50 11/11 4000/1-	
Reverse Recovery Charge	Qrr	_	8.9	_	nC	Is = -11.5A, $dI/dt = 100A/\mu s$	

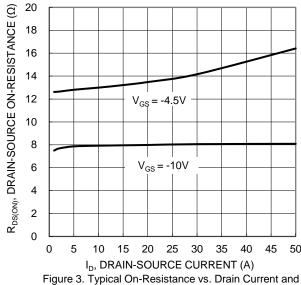
5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided. Notes:

- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.
- 7. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 8. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.
- 9. Short duration pulse test used to minimize self-heating effect.

 10. Guaranteed by design. Not subject to product testing.







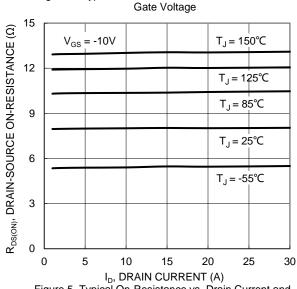


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

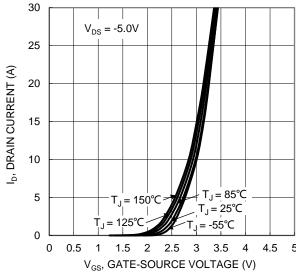
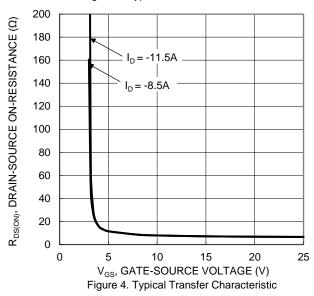


Figure 2. Typical Transfer Characteristic



2 R_{DS(ON)}, DRAIN-SOURCE ON-RESISTANCE (NORMALIZED) 1.8 1.6 $V_{GS} = -10V, I_D = -11.5A$ 1.2 $V_{GS} = -4.5V, I_D = -8.5A$ 1 8.0 0.6 0.4 -50 25 50 75 100 125 T_J, JUNCTION TEMPERATURE (°C)

Figure 6. On-Resistance Variation with Temperature



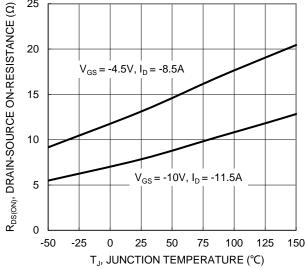
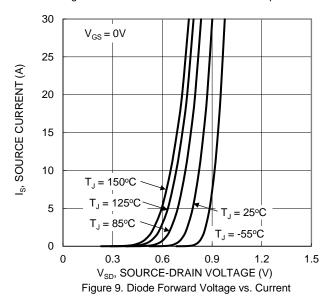


Figure 7. On-Resistance Variation with Temperature



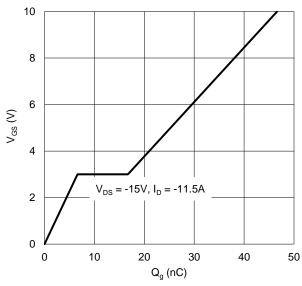


Figure 11. Gate Charge

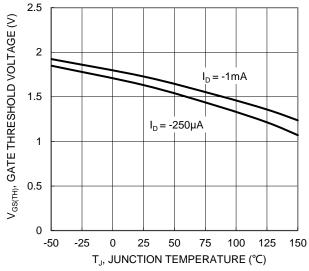
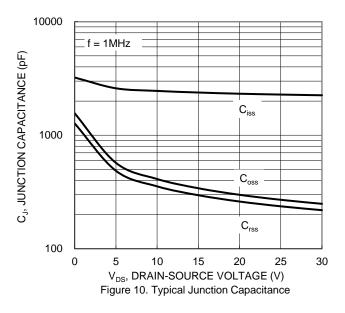


Figure 8. Gate Threshold Variation vs. Temperature





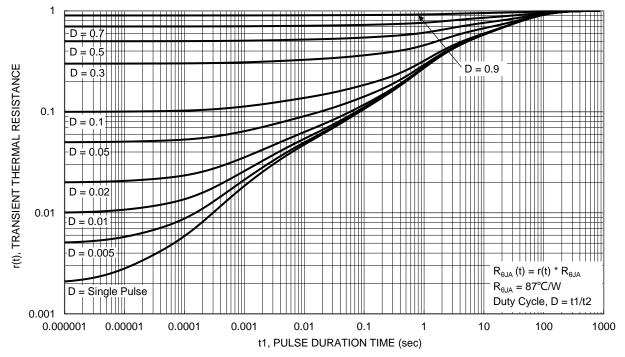


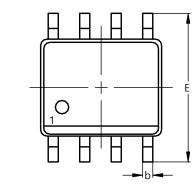
Figure 12. Transient Thermal Resistance

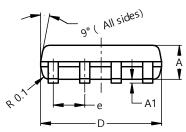


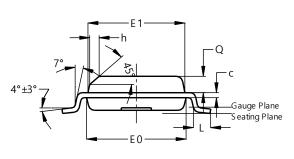
Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8





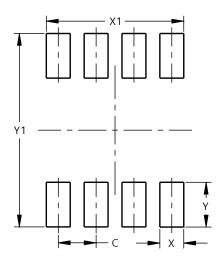


SO-8						
Dim	Min	Max	Тур			
Α	1.40	1.50	1.45			
A1	0.10	0.20	0.15			
q	0.30	0.50	0.40			
C	0.15	0.25	0.20			
D	4.85	4.95	4.90			
Е	5.90	6.10	6.00			
E1	3.80	3.90	3.85			
E0	3.85	3.95	3.90			
е			1.27			
h	-		0.35			
٦	0.62	0.82	0.72			
Ø	0.60	0.70	0.65			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8



Dimensions	Value (in mm)			
C	1.27			
Х	0.802			
X1	4.612			
Y	1.505			
Y1	6.50			

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